# PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the third-listed Assignor's Doc Date previously recorded on Reel 022475 Frame 0424. Assignor(s) hereby confirms the assignment to Sanyo Electric Co., Ltd. and Sanyo Semiconductor Co., Ltd

# **CONVEYING PARTY DATA**

Name	Execution Date
Kikuo OKADA	02/13/2009
Kojiro KAMEYAMA	02/12/2009
Takahiro OIKAWA	02/13/2009

### **RECEIVING PARTY DATA**

Name:	SANYO Electric Co., Ltd.	
Street Address:	2-5-5, Keihanhondori	
City:	Moriguchi-shi, Osaka	
State/Country:	JAPAN	
Postal Code:	570-8677	

Name:	SANYO Semiconductor Co., Ltd.	
Street Address:	1-1-1, Sakata, Oizumi-machi	
City:	Ora-gun, Gunma	
State/Country:	JAPAN	
Postal Code:	370-0596	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12307228

# CORRESPONDENCE DATA

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Fax Number: (703)760-7777

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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Email: NOrdanza@mofo.com
Correspondent Name: Takamitsu Fujiu

PATENT REEL: 022521 FRAME: 0883 .00 1230/228

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S E Address Line 1: c/o Morrison & Foerster, LLP
Address Line 2: 1650 Tysons Blvd. Suite 400
Address Line 4: McLean, VIRGINIA 22102

ATTORNEY DOCKET NUMBER: 606402046700

NAME OF SUBMITTER: Takamitsu Fujiu

Total Attachments: 10
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D: JONATHAN BOCKMAN COMPANY: C/O MORRISON & FOERSTER, LLP

PATENT ASSIGNME	Ξľ	NΤ
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**NEW ASSIGNMENT** 

NATURE OF CONVEYANCE:

**ASSIGNMENT** 

#### **CONVEYING PARTY DATA**

Name	Execution Date
Kikuo OKADA	02/13/2009
Kojiro KAMEYAMA	02/12/2009
Takahiro OIKAWA	03/13/2009

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### **PROPERTY NUMBERS Total: 1**

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Application Number:	12307228

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(703)760-7777

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703-760-7755

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Correspondent Name:

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PATENT <u>REFL: 022521 FRAME: 0885</u> USPTO

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Fax Server

D: JONATHAN BOCKMAN COMPANY: C/O MORRISON & FOERSTER, LLP

Address Line 4: McLean, VIRGINIA 22102		
ATTORNEY DOCKET NUMBER: 606402046700		
NAME OF SUBMITTER:	Jonathan Bockman	
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**PATENT** 

REEL: 022521 FRAME: 0886

### MORRISON & FOERSTER LLP

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assigns, transfers and sets over to:

SANYO Electric Co., Ltd. 2-5-5, Keihanhondori Moriguchi-Shi, Osaka 570-8677 Japan

#### And

SANYO Semiconductor Co., Ltd. 1-1-1, Sakata, Oizumi-Machi, Ora-Gun Gunma 370-0596 Japan

(hereinafter designated as the "ASSIGNEES"), its successors and assigns, the entire right, title, and interest for the United States in the invention, and all applications for patent and any Letters Patent which may be granted therefore, including said application, and all United States Letters Patent which may be granted thereof, and all divisions, reissues, continuations and extensions thereof, the said interest being the entire ownership of said Letters Patent when granted to be held by said ASSIGNEES, its successors, assigns or their legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been and enjoyed by Assignor(s) if this assignment had not been made, the application being known by the title:

### ELECTRODE STRUCTURE AND SEMICONDUCTOR DEVICE

Attorney Docket No.: 606402046700

for which the undersigned has/have executed an application for patent in the United States of America on the same day herewith. Where this instrument is not filed concurrently with the application, the following identifying information may be added after execution:

Serial No.: 12/307,228 Filing Date: December 31, 2008

- 1. The undersigned hereby agrees to sign and execute any further documents and instruments which may be necessary, lawful and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reexamination or reissue application or in any amendments, extension of interference proceedings, or otherwise to secure the title thereto to the ASSIGNEES.
- 2. The undersigned agrees to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property of similar agreements.
- 3. The undersigned agrees to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the ASSIGNEES.

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- 4. The undersigned hereby authorizes and requests the Commissioner of Patents in the United States to issue any and all Letters Patent resulting from said application or any division or divisions or continuing applications thereof to the said ASSIGNEES.
- 5. The undersigned hereby grants to the firm of Morrison & Foerster LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREBY, executed by the undersigned on the date opposite the undersigned name.

Peb. 13, 09	Xipuo Okorpa
Date	Name: Kikuo OKADA
<u> Zeb. 12. o 9</u> Date	Name: Kojiro KAMEYAMA
	•
Feb. 13, 2009	Jakahiro Oikawa Name: Takahiro OIKAWA